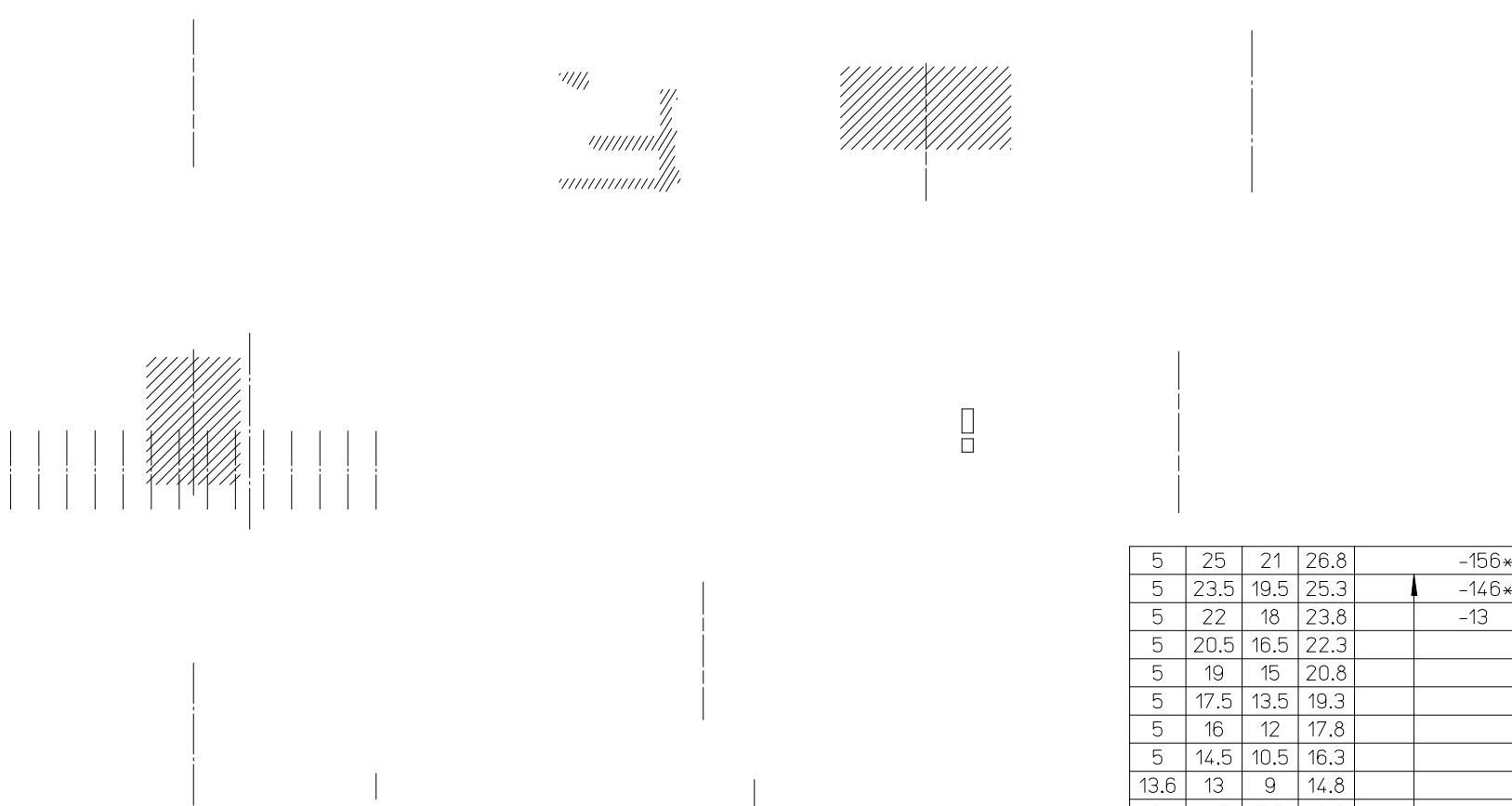


10 9 8 7 6 5 4 3 2 1



5	25	21	26.8	-156*	15
5	23.5	19.5	25.3	-146*	14
5	22	18	23.8	-13	13
5	20.5	16.5	22.3		12
5	19	15	20.8		11
5	17.5	13.5	19.3		10
5	16	12	17.8		9
5	14.5	10.5	16.3		8
13.6	13	9	14.8		7
12.1	11.5	7.5	13.3		6
10.6	10	6	11.8		5
9.1	8.5	4.5	10.3		4
7.6	7	3	8.8		3
6.1	5.5	1.5	7.3	502584	2
D	C	B	A	EMBOSSED TAPE PACKAGE 注文番号 ORDER No.	CIRCUIT No.

No.	部品 PART	材料 MATERIAL
①	ハウジング HOUSING	耐熱性樹脂 UL94V-0 HEATPROOF RESIN UL94V-0
②	ターミナル TERMINAL	銅合金 COPPER ALLOY
		錫めっき: 1.0 micro-meter MIN. TIN (TAIL AREA)
③	ネイル NAIL	銅合金 COPPER ALLOY
		錫めっき: 1.0 micro-meter MIN. TIN
		ニッケルめっき(下地): 1.0 micro-meter MIN. NICKEL (UNDER PLATING)

EC NO: J2013-1045 DRWN: NITO 2013/03/25 CHKD: KASAKAWA 2013/03/25 APPR: Y01TO 2013/03/26	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		10 UNDER	±0.2	DRAWN BY NITO	DATE 2008/07/03	TITLE 1.5 MM W/B CONN. S/T REC. ASSY WITH KAPTON TAPE			
		10 OVER 30 UNDER	±0.25	CHECKED BY KASAKAWA	DATE 2008/07/03	molex DOCUMENT NO. SD-502584-003 SHEET NO. 1 OF 1			
		30 OVER	±0.3	APPROVED BY SICHIKAWA	DATE 2008/07/03				
ANGULAR ±1 °		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

9 8 7 6 5 4 3 2